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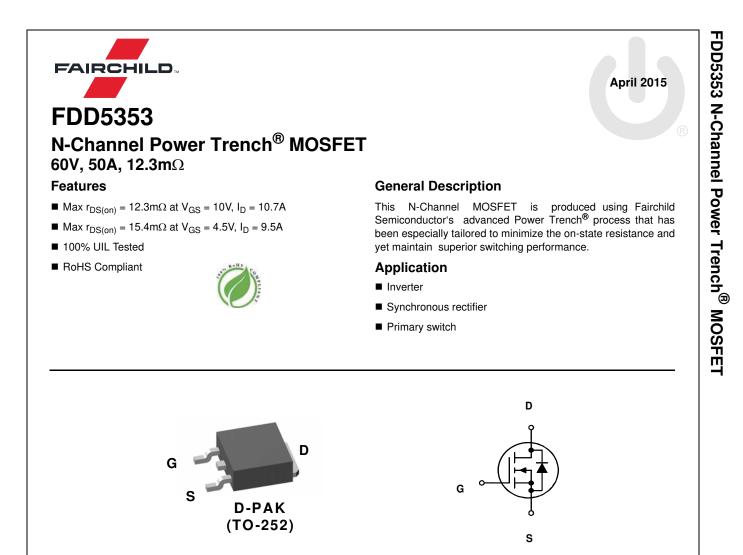


ON Semiconductor®

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MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	$T_{\rm C} = 25^{\circ}{\rm C}$		50		
	-Continuous	T _A = 25°C	(Note 1a)	11.5	Α	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	253	mJ	
P _D	Power Dissipation	T _C = 25°C		69	w	
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	3.1		
TJ, T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	40	0/11

Package Marking and Ordering Information

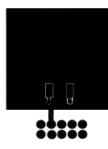
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD5353	FDD5353	D-PAK (TO-252)	13"	16mm	2500 units

FDD5353
N-Channel
Power
Trench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0V$	60			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		77		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 48V,$			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \mu A$	1.0	1.8	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-8		mV/°C	
Ū	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 10.7A		10.1	12.3	12.3 15.4 mΩ	
r _{DS(on)}		$V_{GS} = 4.5V, I_D = 9.5A$		12.1	15.4		
		V _{GS} = 10V, I _D = 10.7A, T _J = 125°C		16.7	20.3	1	
9fs	Forward Transconductance	$V_{DD} = 5V, I_D = 10.7A$		41		S	
•	Characteristics			1	I	T	
C _{iss}	Input Capacitance			2420	3215	pF	
C _{oss}	Output Capacitance	f = 1MHz		215	285	pF	
C _{rss}	Reverse Transfer Capacitance			120	180	pF	
R _g	Gate Resistance	f = 1MHz		1.7		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			11	20	ns	
t _r	Rise Time	V _{DD} = 30V, I _D = 10.7A,		6	11	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		36	58	ns	
t _f	Fall Time			4	10	ns	
Qg	Total Gate Charge	$\frac{V_{GS} = 0V \text{ to } 10V}{V_{GS} = 0V \text{ to } 4.5V} V_{DD} = 30V, \\ I_D = 10.7A$		46	65	nC	
Qg	Total Gate Charge			23	32	nC	
Q _{gs}	Gate to Source Charge			7		nC	
Q _{gd}	Gate to Drain "Miller" Charge			9		nC	
Drain-Soເ	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 10.7A$ (Note 2)		0.8	1.3	v	
▼ SD		$V_{GS} = 0V, I_S = 2.6A$ (Note 2)		0.7	1.2	v	
t _{rr}	Reverse Recovery Time	I _F = 10.7A, di/dt = 100A/μs		28	45	ns	
Qrr	Reverse Recovery Charge	$T_{F} = 10.7 \text{A}, \text{ u/ul} = 100 \text{A/} \mu \text{S}$		21	34	nC	

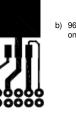
 Q_{rr}

Notes: 13 R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,JC} is guaranteed by design while R_{0,JA} is determined by the user's board design.



Reverse Recovery Charge

a) 40°C/W when mounted on a 1 in² pad of 2 oz copper



b) 96°C/W when mounted on a minimum pad.

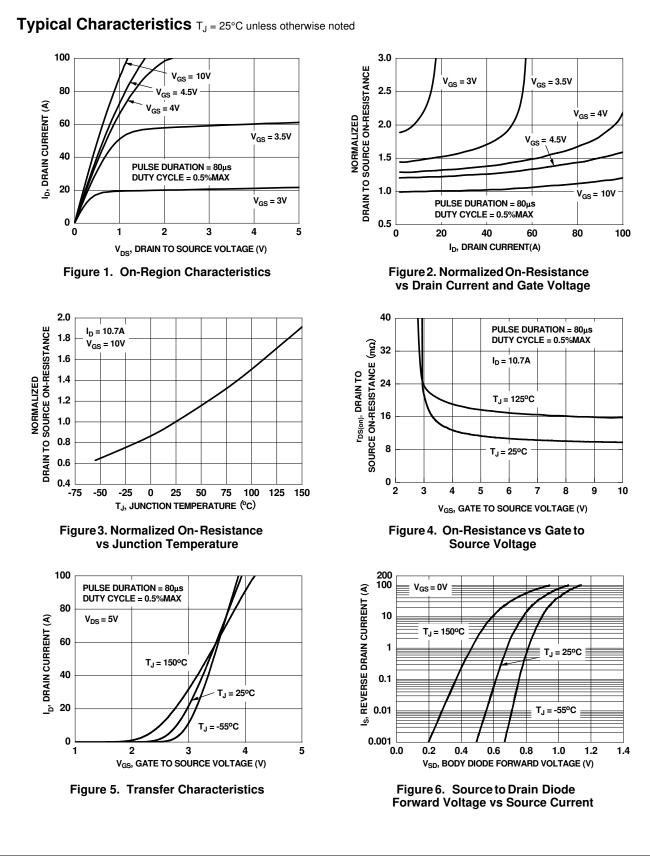
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34

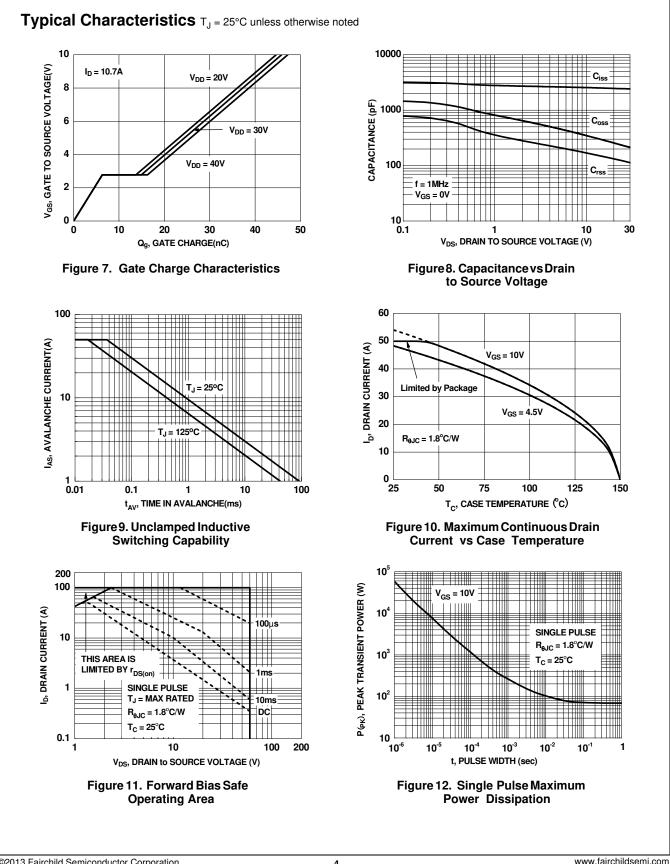
nC



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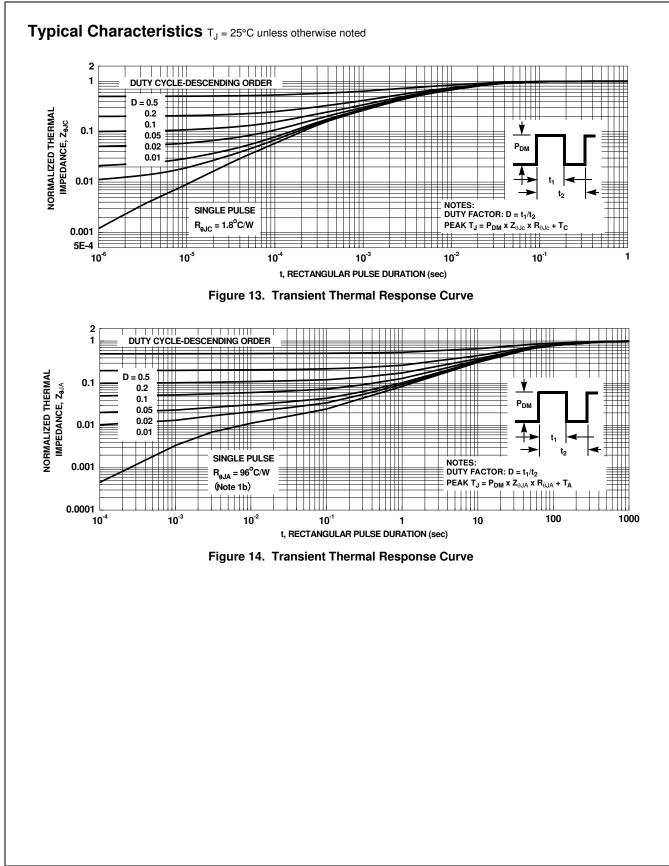


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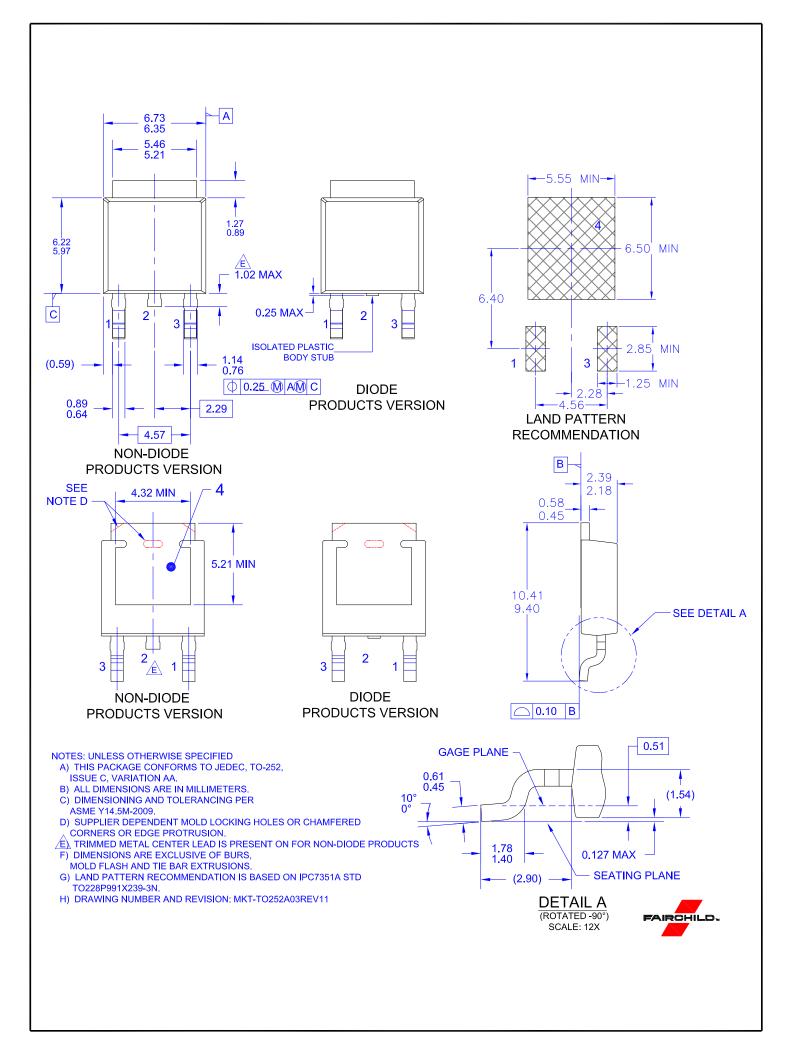
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